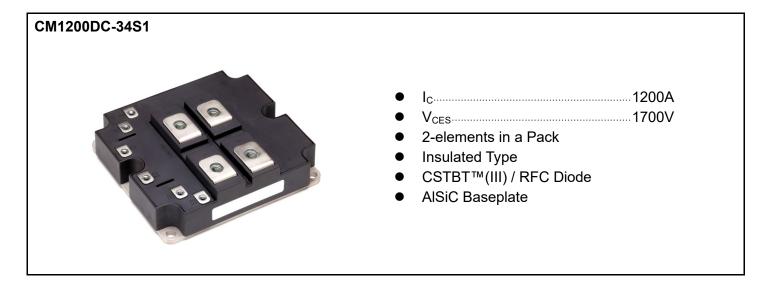


< High Voltage Insulated Gate Bipolar Transistor: HVIGBT >

CM1200DC-34S1

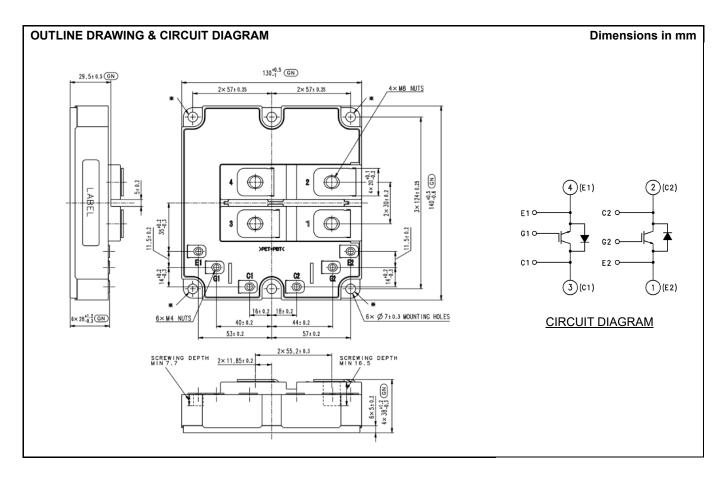
HIGH POWER SWITCHING USE INSULATED TYPE

5th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules



APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers



MAXIMUM RATINGS

Item	Symbol	Conditions			Unit	
Collector-emitter voltage Gate-emitter short-circuited	V _{CES}	V _{GE} = 0 V	1700 1650	V		
Gate-emitter voltage Collector-emitter short-circuited	V _{GES}	$T_{j} = -50 \text{ °C}$ $V_{CE} = 0 \text{ V}$ $T_{j} = 25 \text{ °C}$			v	
Collector current	Ι _c	T _c = 90 °C , DC		1200	Α	
(Repetitive peak) Collector current	I _{CRM}	Pulse (Note 1)		2400	Α	
Emitter current	Ι _Ε	DC (Note 2)	C (Note 2)			
(Repetitive peak) Emitter current	I _{ERM}	Pulse (Note 1, 2)	2400	Α		
Total power dissipation	P _{tot}	T _c = 25 °C , IGBT part(Note 3)	6750	W		
Isolation voltage	V _{isol}	Charged part to the baseplate RMS sinusoidal, 60Hz 1min			V _{rms}	
Partial discharge charge	Q _{pd}	Charged part to the baseplate, RMS sinusoidal, 60 Hz $V_1 = 3500 \text{ V}, V_2 = 2600 \text{ V}, (acc. to IEC 61287-1)$			рС	
Junction temperature	Ti	Maximum temperature range in off-state or on-state(non-switching)			°C	
Storage temperature	T _{stg}	Maximum case temperature range in off-state			°C	
Operating junction temperature	Tjop	Maximum junction temperature range for switching operation			°C	
Turn-off cllector current	I _{C(off)}	V_{GE} = ±15 V , L _s = 70 nH , $R_{G(off)}$ = 3.3 Ω , V_{CC} ≤1200V, V_{CE} ≤1700V	T _i = 150 °C	2400	Α	
Short-circuit withstand pulse duration	t _{pSC}	V_{GE} = ±15 V , $L_s \le$ 70 nH , $R_{G(off)}$ = 3.3 Ω , VCC \le 1200V, $V_{CE} \le$ 1700V	T _i = 150 °C	10	μs	
Reverse recovery power dissipation	Prr	I _E = 2400 A , L _s = 70 nH , V _{CC} ≤1200V, di/dt≤8000A/us,V _{CE} ≤1700V	T _i = 150 °C	1.1	MW	

ELECTRICAL CHARACTERISTICS

Item	Symphol	Conditions		Limits			Unit
Item	Symbol	Conditions			Min. Typ. M		Unit
Collector omitter out off ourrent			T _j = 25 °C	-	-	4.0	mA
Collector-emitter cut-off current Gate-emitter short-circuited	I _{CES}	V _{CE} = 1700 V , V _{GE} = 0 V	T _j = 125 °C	-	1.8	-	mA
Gate-enfiller short-circuited			T _j = 150 °C	-	-	40.0	mA
Gate-emitter threshold voltage	V _{GE(th)}	V _{CE} = 10 V , I _C = 120mA	T _i = 25 °C	5.40	6.00	6.60	V
Gate leakage current Collector-emitter short-circuited	I _{GES}	V _{CE} = 0 V , V _{GE} = ±20 V	T _j = 25 °C	-0.5	-	0.5	μA
Gate charge	Q_{G}	$V_{CC} = 850 \text{ V}$, $I_{C} = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$	T _i = 25 °C	-	12.0	-	μC
Input capacitance	Cies	V _{CE} = 10 V , V _{GE} = 0 V , f = 100kHz	T _i = 25 °C	-	216	-	nF
Output capacitance	C _{oes}	V _{CE} = 10 V , V _{GE} = 0 V , f = 100kHz	T _j = 25 °C	-	8.0	-	nF
Reverse transfer capacitance	Cres	V _{CE} = 10 V , V _{GE} = 0 V , f = 100kHz	T _j = 25 °C	-	1.6	-	nF
Collector-emitter saturation voltage	V _{CEsat}	I _C = 1200 A , V _{GE} = +15 V(Note 4)	T _j = 25 °C	-	1.95	-	V
			T _i = 125 °C	-	2.25	-	V
			T _i = 150 °C	-	2.30	2.80	V
		I _E = 1200 A , V _{GE} = 0 V(Note 2, 4)	T _j = 25 °C	-	2.20	-	V
Emitter-collector voltage	V _{EC}		T _j = 125 °C	-	2.35	-	V
			T _i = 150 °C	-	2.35	2.85	V
Turn-on delay time	t _{d(on)}		T _i = 150 °C	-	-	1.10	μs
Rise time	ţ,		T _j = 150 °C	-	-	0.41	μs
		$1 = 850 \times 1 = 1200 \wedge 1 = \pm 15 \times 1 = 70 \text{ pH}$	T _j = 25 °C	-	265	-	mJ
Turn-on (switching) energy per pulse 10% integral	E _{on(10%)}	$V_{CC} = 850 \text{ V} , \text{ I}_{C} = 1200 \text{ A} , \text{ V}_{GE} = \pm 15 \text{ V} , \text{ L}_{s} = 70 \text{ nH}$ $R_{G(on)} = 1.3 \Omega , R_{G(off)} = 3.3 \Omega$ Inductive load(Note 5)	T _j = 125 °C	-	350	-	mJ
			T _i = 150 °C	-	355	-	mJ
	ilse E _{on}		T _i = 25 °C	-	290	-	mJ
Turn-on (switching) energy per pulse			T _i = 125 °C	-	370	-	mJ
			T _i = 150 °C	-	380	-	mJ

ELECTRICAL CHARACTERISTICS

ltem	Symbol	Conditions			Limits	-	Unit
nem	Oymbol			Min.	Тур.	Max.	Onit
			T _j = 25 °C	-	0.30	-	μs
Reverse recovery time	t _{rr}		T _i = 125 °C	-	0.40	-	μs
			T _i = 150 °C	-	0.45	-	μs
			T _j = 25 °C	-	735	-	A
Reverse recovery current	I _{rr}		T _j = 125 °C	-	865	-	A
			T _j = 150 °C	-	875	-	Α
			T _j = 25 °C	-	190	-	μC
Reverse recovery charge 10% integral	Q _{rr(10%)}	V _{CC} = 850 V , I _F = 1200 A , V _{GF} = ±15 V , L _s = 70 nH	T _j = 125 °C	-	295	-	μC
			T _i = 150 °C	-	365	-	μC
		$R_{G(on)} = 1.3 \Omega , R_{G(off)} = 3.3 \Omega$ Inductive load(Note 2, 5, 6)	T _i = 25 °C	-	265	-	μC
Reverse recovered charge	Q _{rr}		T _j = 125 °C	-	340	-	μC
			T _j = 150 °C	-	420	-	μC
	E _{rec(10%)}		T _j = 25 °C	-	90	-	mJ
Reverse recovery energy per pulse 10% integral			T _j = 125 °C	-	150	-	mJ
			T _j = 150 °C	-	195	-	mJ
	E _{rec}		T _i = 25 °C	-	150	-	mJ
Reverse recovery energy			T _i = 125 °C	-	190	-	mJ
			T _j = 150 °C	-	240	-	mJ
			T _j = 25 °C	-	1.20	-	μs
Turn-off delay time	t _{d(off)}		T _j = 125 °C	-	1.30	-	μs
			T _j = 150 °C	-	1.32	-	μs
			T _i = 25 °C	-	0.12	-	μs
Fall time	t _r		T _i = 125 °C	-	0.15	-	μs
		$V_{cc} = 850 \text{ V}$, $I_c = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$	T _i = 150 °C	-	0.17	-	μs
Turn-off (switching) energy per pulse 10% integral	E _{off(10%)}	$R_{G(on)} = 1.3 \Omega$, $R_{G(off)} = 3.3 \Omega$ Inductive load(Note 5)	T _j = 25 °C	-	200	-	mJ
		Inductive load(NOLE 3)	T _j = 125 °C	-	280	-	mJ
			T _j = 150 °C	-	310	-	mJ
			T _j = 25 °C	-	260	-	mJ
Turn-off (switching) energy per pulse	E _{off}		T _i = 125 °C	-	360	-	mJ
			T _i = 150 °C	-	400	-	mJ

Note1. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{jopmax} rating.

Note2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWD_i).

Note3. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).

Note4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

Note5. The integration range of switching energies (E_{on(10%)}, E_{rec(10%)}, E_{off(10%)}) is from 10%V_{CE} to 10%I_C(10%I_E).

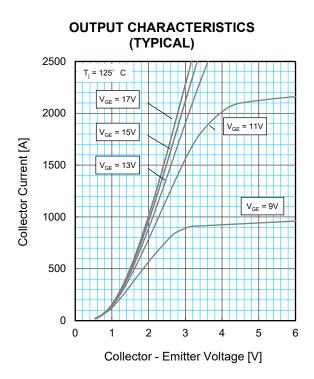
Note6. The integration range of reverse recovery charge($Q_{rr(10\%)}$) is from $I_E = 0A$ to $10\% I_E$.

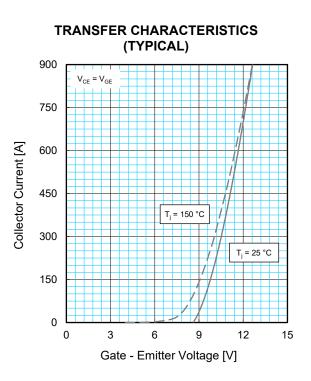
THERMAL CHARACTERISTICS

Itom	Symbol	Conditions	Limits			Unit
Item	Зупроі	bol Conditions -		Тур.	Max.	Unit
Thermal resistance junction to case, IGBT	R _{th(j-c)Q}	Junction to Case, IGBT part, 1/2 module	-	-	18.5	K/kW
Thermal resistance Junction to case, DIODE	R _{th(j-c)D}	Junction to Case, FWDi part, 1/2 module	-	-	38.0	K/kW
Contact thermal resistance case to heatsink	$R_{th(c-s)}$	Case to heat sink, 1/2 module λ _{grease} = 1 W/m·k, D _(c-s) = 100 μm	-	16.0	-	K/kW

MECHANICAL CHARACTERISTICS

Item	Cumbal	Conditions			Limits	
liem	Symbol	Conditions		Тур.	Max.	Unit
Mounting torque		Main terminals screw: M8	7.0	-	20.0	N∙m
Mounting torque	Mt	Mounting screw: M6	3.0	-	6.0	N∙m
Mounting torque		Auxiliary terminals screw. M4	1.0	-	3.0	N∙m
Mass	m	-		0.8	-	kg
Comparative tracking index	CTI	60		-	-	-
Clearance distance in air	d _a	ollector main terminal - Emitter main terminal 9. erminal - Baseplate		-	-	mm
Creepage distance along surface	ds	Collector main terminal - Emitter main terminal	15.0	-	-	mm
Creepage distance along surface	ds	Terminal - Baseplate	15.0	-	-	mm
Internal inductance (C-E)	L _{P(C-E)}	1/2 module, IGBT part, Tc=25°C	-	22	-	nH
Internal lead resistance, CC'-EE'	R _{CC'+EE'}	1/2 module, IGBT part, T _c =25°C	-	0.16	-	mΩ

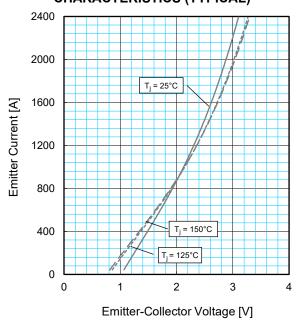


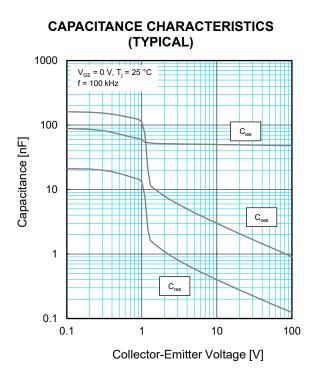


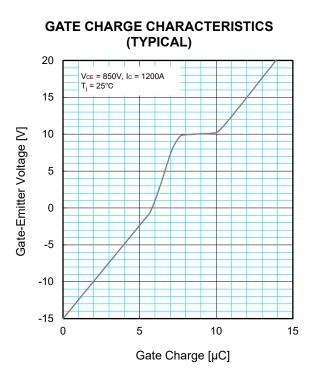
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL) 2400 V_{GE} = 15V 2000 Collector Current [A] T, = 25°C 1600 T₁ = 125°C 1200 T₁ = 150°C 800 400 0 2 3 4 0 1

Collector-Emitter Saturation Voltage [V]

FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)

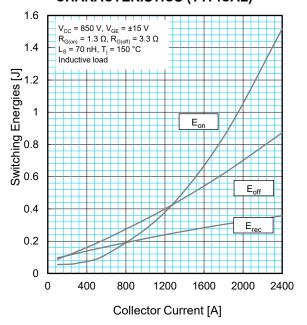


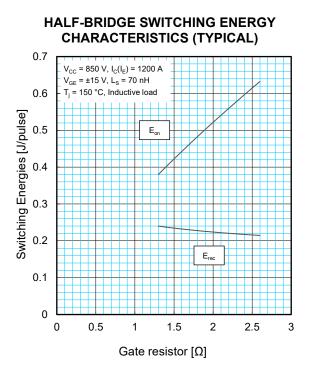


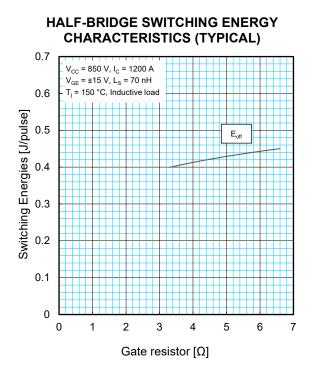


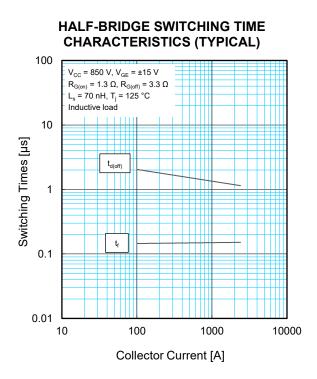
HALF-BRIDGE SWITCHING ENERGY **CHARACTERISTICS (TYPICAL)** 1.6 V_{CC} = 850 V, V_{GE} = ±15 V $R_{G(on)} = 1.3 \Omega, R_{G(off)} = 3.3 \Omega$ L_s = 70 nH, T_i = 125 °C 1.4 Inductive load E E_{off} 0.4 Erec 0.2 0 800 400 1200 1600 2000 2400 0 Collector Current [A]

HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

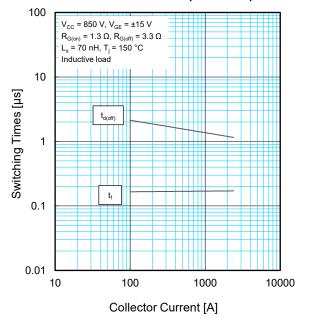


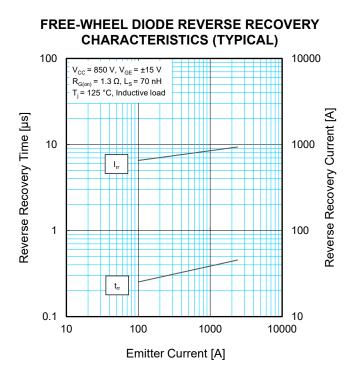


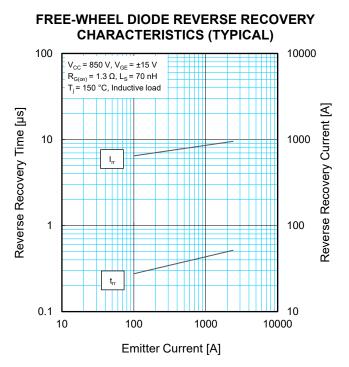


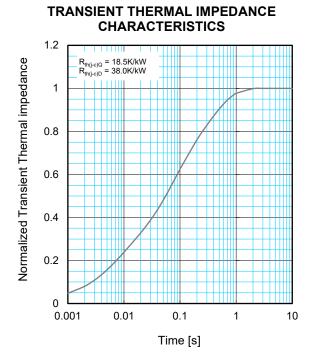


HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



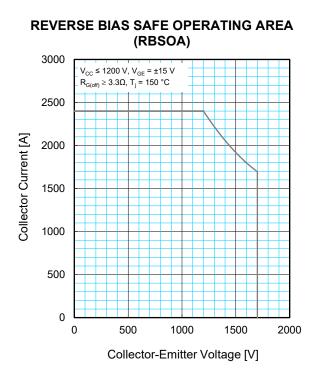


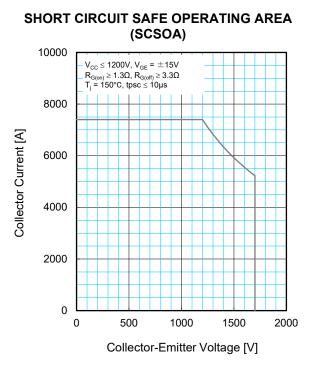




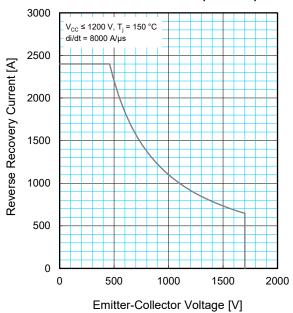
$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_i \left\{ 1 - exp^{\left(-\frac{t}{\tau_i}\right)} \right\}$$

	1	2	3	4
R _i [K/kW] :	0.0096	0.1893	0.4044	0.3967
τi [sec.] :	0.0001	0.0058	0.0602	0.3512





FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



Nov. 2024 (HVM-1144-B)

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